



BAS21AW-Q

High-voltage switching diode

5 January 2023

Product data sheet

1. General description

High-voltage switching diode encapsulated in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: $t_{rr} \leq 50$ ns
- Low leakage current
- High reverse voltage $V_R \leq 250$ V
- Low capacitance: $C_d \leq 2$ pF
- Very small SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High-speed switching at high voltage
- High-voltage general-purpose switching
- Voltage clamping
- Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

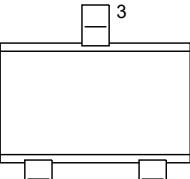
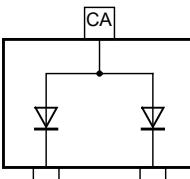
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
I_F	forward current		[1]	-	-	225	mA
I_R	reverse current	$V_R = 200$ V; $T_{amb} = 25$ °C		-	-	100	nA
V_R	reverse voltage			-	-	250	V
t_{rr}	reverse recovery time	$I_F = 10$ mA; $I_R = 10$ mA; $R_L = 100$ Ω; $I_{R(meas)} = 1$ mA; $T_{amb} = 25$ °C		-	-	50	ns

[1] Single diode loaded.

nexperia

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 SC-70 (SOT323)	
2	K2	cathode (diode 2)		
3	CA	common anode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS21AW-Q	SC-70	plastic, surface-mounted package; 3 leads; 1.3 mm pitch; 2 mm x 1.25 mm x 0.95 mm body	SOT323

7. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
BAS21AW-Q	X6%

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V_R	reverse voltage			-	250	V
I_F	forward current		[1]	-	225	mA
			[2]	-	125	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 1 \mu s$; square wave; $T_{j(init)} = 25^\circ C$		-	9	A
		$t_p = 100 \mu s$; square wave; $T_{j(init)} = 25^\circ C$		-	3	A
		$t_p = 10 ms$; square wave; $T_{j(init)} = 25^\circ C$		-	1.7	A
I_{FRM}	repetitive peak forward current			-	625	mA
Per device						
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ C$	[3]	-	200	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Single diode loaded.

[2] Double diode loaded.

[3] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

9. Thermal characteristics

Table 6. Thermal characteristics

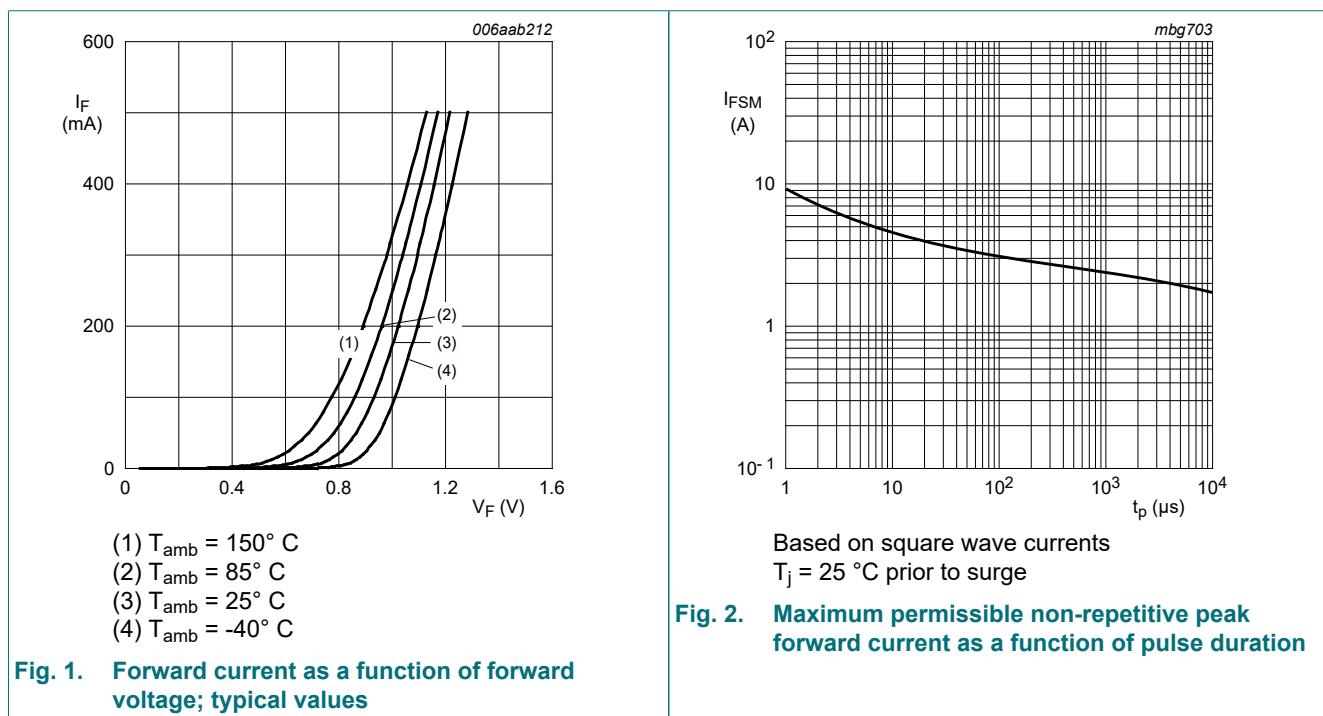
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	625	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	-	300	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
V _F	forward voltage	I _F = 100 mA; T _{amb} = 25 °C		-	-	1	V
		I _F = 200 mA; T _{amb} = 25 °C		-	-	1.25	V
I _R	reverse current	V _R = 200 V; T _{amb} = 25 °C		-	-	100	nA
		V _R = 200 V; T _j = 150 °C		-	-	100	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _{amb} = 25 °C		-	-	2	pF
t _{rr}	reverse recovery time	I _F = 10 mA; I _R = 10 mA; R _L = 100 Ω; I _{R(meas)} = 1 mA; T _{amb} = 25 °C		-	-	50	ns



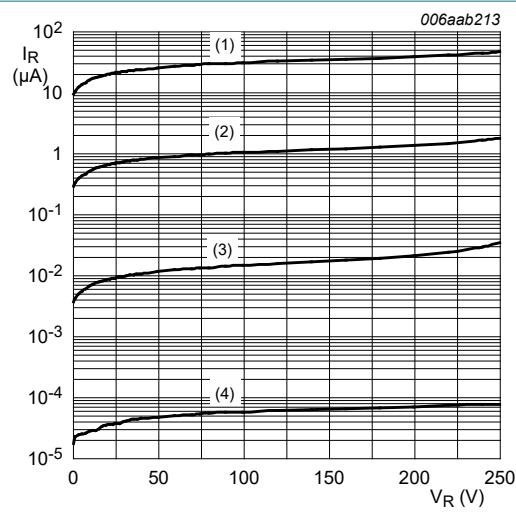


Fig. 3. Reverse current as a function of reverse voltage; typical values

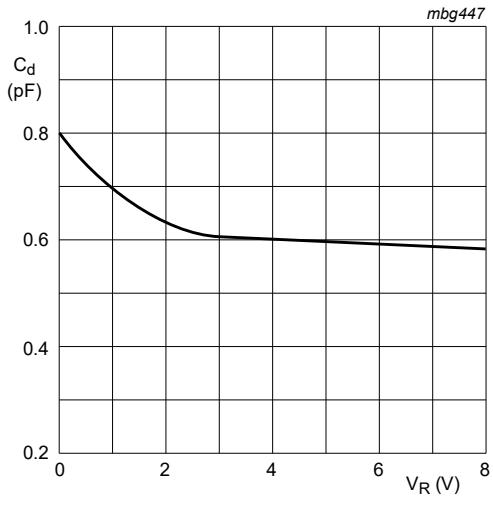
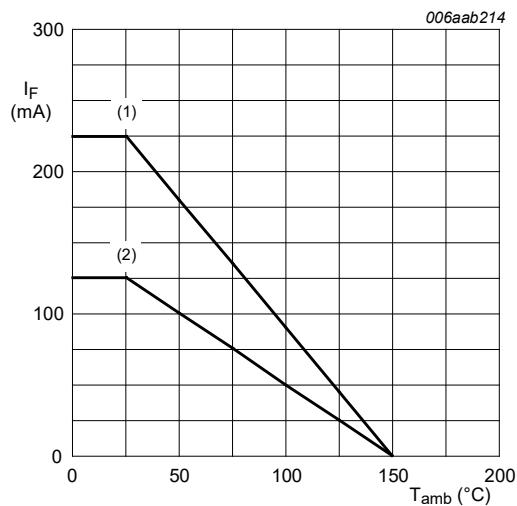


Fig. 4. Diode capacitance as a function of reverse voltage; typical values.



FR4 PCB, standard footprint
(1) Single diode loaded
(2) Double diode loaded

Fig. 5. Forward current as a function of ambient temperature; derating curves

11. Test information

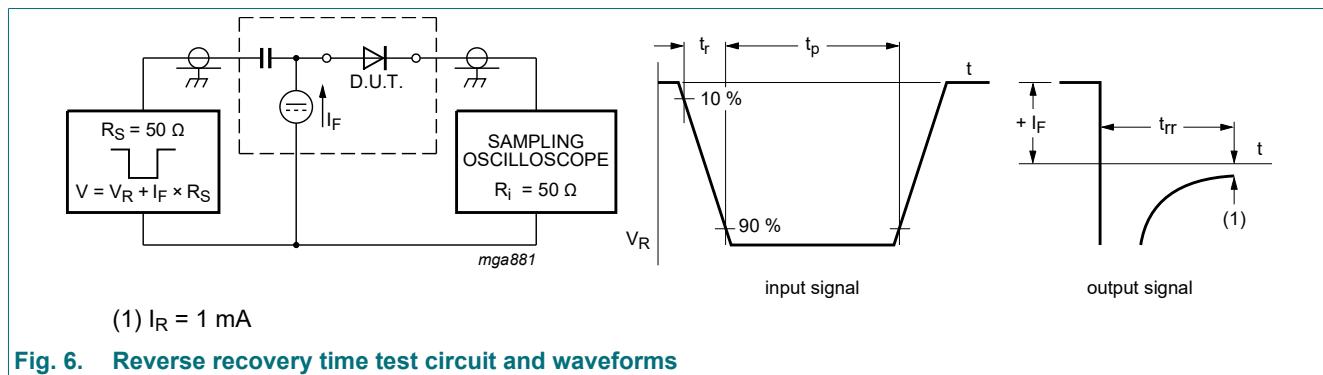


Fig. 6. Reverse recovery time test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

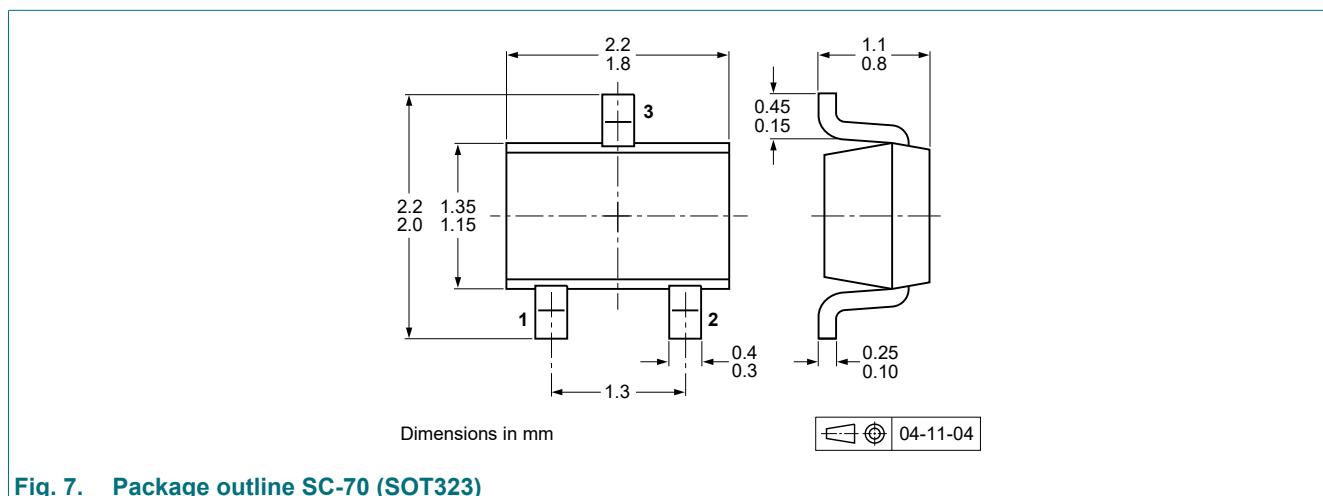
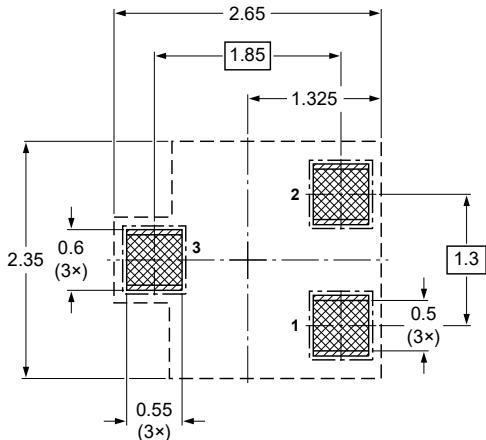


Fig. 7. Package outline SC-70 (SOT323)

13. Soldering



solder lands

solder resist

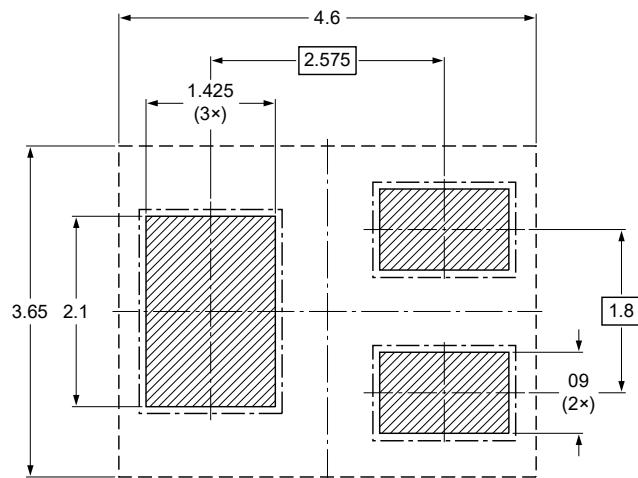
solder paste

occupied area

Dimensions in mm

sot323_fr

Fig. 8. Reflow soldering footprint for SC-70 (SOT323)



solder lands

solder resist

occupied area

Dimensions in mm

preferred transport
direction during soldering

sot323_fw

Fig. 9. Wave soldering footprint for SC-70 (SOT323)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS21AW-Q v.3	20230105	Product data sheet	-	BAS21AW-Q v.2
Modifications:	<ul style="list-style-type: none">Section 1 General description: Typo corrected.			
BAS21AW-Q v.2	20220120	Product data sheet	-	BAS21W_SER_1
BAS21W_SER_1	20091009	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 5 January 2023
